&TDK Multilayer Ceramic Chip Capacitors

C0402X5R1A222K020BC



TDK item description C0402X5R1A222KT****

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Applications	Commercial Grade	
Feature	General General (Up to 50V)	
Series	C0402 [EIA 01005]	a de la companya de la
Status	Production (Not Recommended for New Design)	Dimensions in n

Size		
Length(L)	0.40mm ±0.02mm	
Width(W)	0.20mm ±0.02mm	
Thickness(T)	0.20mm ±0.02mm	
Terminal Width(B)	0.07mm Min.	
Terminal Spacing(G)	0.14mm Min.	
Recommended Land Pattern (PA)	0.15mm to 0.25mm	
Recommended Land Pattern (PB)	0.15mm to 0.25mm	
Recommended Land Pattern (PC)	0.15mm to 0.25mm	

Electrical Characteristics		
Capacitance	2.2nF ±10%	
Rated Voltage	10VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	10000ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	20000pcs

! Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

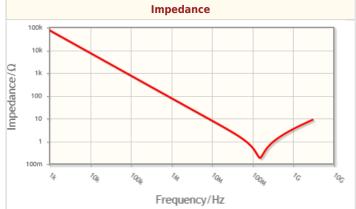
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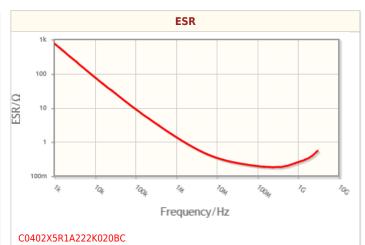
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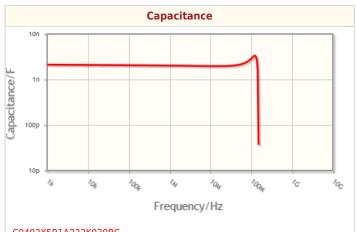


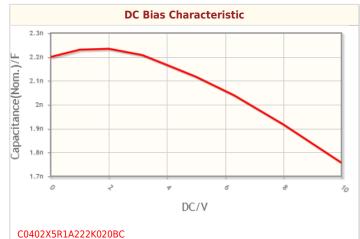
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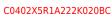


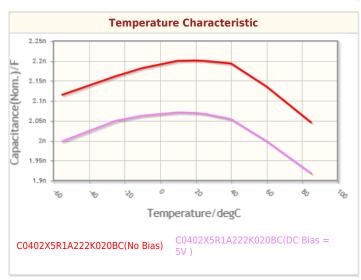


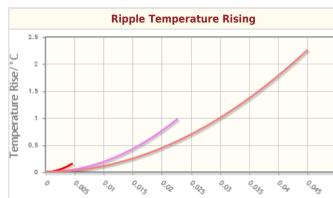
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Ripple Current/Arms

C0402X5R1A222K020BC(100kHz) C0402X5R1A222K020BC(500kHz) C0402X5R1A222K020BC(1MHz)

Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

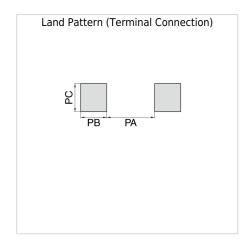
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Associated Images



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